XP0121M

Silicon NPN epitaxial planar transistor

For digital circuits/switching

■ Features

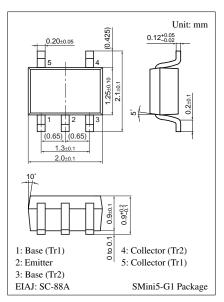
- Two elements incorporated into one package (Emitter-coupled transistors built-in resistor)
- Reduction of the mounting area and assembly cost by one half

■ Basic Part Number of Element

• UNR121M (UN121M) × 2 elements

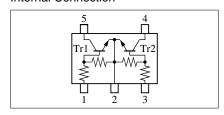
■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Rating	Collector to base voltage	V_{CBO}	50	V	
of	Collector to emitter voltage	V _{CEO}	50	V	
element	Collector current	I_C	100	mA	
Total	Total power dissipation	P_{T}	150	mW	
	Junction temperature	T _j	150	°C	
	Storage temperature	T_{stg}	-55 to +150	°C	



Marking Symbol: EM

Internal Connection

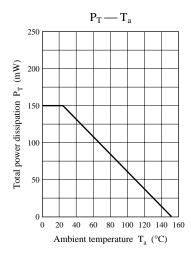


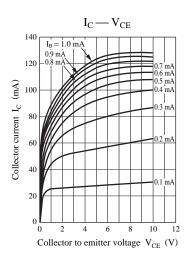
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

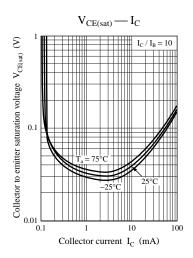
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector to base voltage	V _{CBO}	$I_C = 10 \ \mu A, \ I_E = 0$	50			V
Collector to emitter voltage	V _{CEO}	$I_C = 2 \text{ mA}, I_B = 0$	50			V
Collector cutoff current	I_{CBO}	$V_{CB} = 50 \text{ V}, I_E = 0$			0.1	μΑ
	I _{CEO}	$V_{CE} = 50 \text{ V}, I_B = 0$			0.5	
Emitter cutoff current	I _{EBO}	$V_{EB} = 6 \text{ V}, I_{C} = 0$			0.2	mA
DC current gain	h _{FE}	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$	80			
DC current gain ratio *	h _{FE(Small/Large)}	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$	0.5	0.99		
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA}$		0.06	0.25	V
High level output voltage	V _{OH}	$V_{CC} = 5 \text{ V}, V_{B} = 0.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$	4.9			V
Low level output voltage	V _{OL}	$V_{CC} = 5 \text{ V}, V_{B} = 2.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$			0.2	V
Input resistance	R ₁		-30%	2.2	+30%	kΩ
Resistance ratio	R_1/R_2			0.047		
Gain bandwidth product	f_T	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz

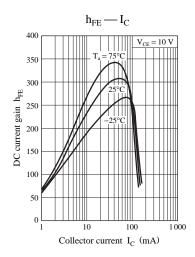
Note) *: Ratio between one and another device

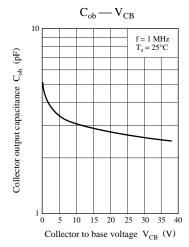
Note) The part number in the parenthesis shows conventional part number.

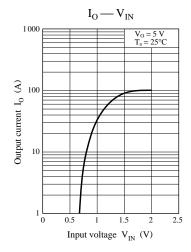


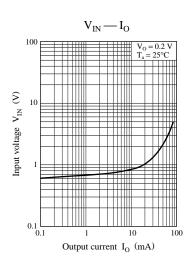












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